Name of conveying party(ies): Jae Woon KIM and 2) Jong Hoon PARK	2. Name and address of receiving party(ies): Name: LG SEMICON CO., LTD.
) Jae Woon KIM and 2) Jong Hoon PARK	
	Name: LG SEMICON CO., LTD.
	Internal Address:
additional name(s) of conveying party(ies) attached?Yes X_No	
3. Nature of conveyance:	
X. Assignment Merger	Street Address: 1. Hyangjeong-Dong, Hungduk-Gu
Security Agreement Change of Name	City: <u>Cheongju</u>
Other	State/Country: <u>Choongcheongbuk-Do. Korea</u> ZIP:
Execution Date: 1) August 29 1998; 2) September 10, 1998	Additional name(s) & address(es) attached? _ Yes _X_ No
A. Patent Application No(s).: Filed:	ation date of the application is: 1) August 29, 1998; 2) September 10, 1999 B. Patent No(s) hed? Yes _X_ No
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: FLESHNER & KIM	7. Total fee (37 C.F.R. 3.41)\$40.00
Internal Address:	X Enclosed (Check No. 6207)
	Authorized to be charged to deposit account
Street Address: P. O. Box 221200	8. Deposit account number:
	1 <u>6-0607</u>
City Chantilly State VA 7ID 20152 1300	11.1111
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original document.	n is true and correct and any attached copy is a true copy of the September 17, 1998
	Security Agreement Change of Name Other Execution Date: 1) August 29, 1998; 2) September 10, 1998 4. Application number(s) or patent number(s): If the document is being filed together with a new application, the exect A. Patent Application No(s).: Filed: Additional numbers attact 5. Name and address of party to whom correspondence concerning document should be mailed: Name:FLESHNER & KJM Internal Address: Street Address: Street Address: P. O. Box 221200 City: Chantilly State: VA ZIP: 20153-1200 DO NOT USE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information

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CMB No. 0851-0011 (exp. 4/94)

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PATENT REEL: 9471 FRAME: 0637

Total number of pages comprising cover sheet: 2

Docket No.: LGS/P-148

ASSIGNMENT

In consideration of the premises and other good and valuable con undersigned,	isideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the
(1)	(4)
(2)Jong Hoon PARK	(5)
(3)	
who have made a certain new and useful invention, hereby sell, assign and	
LG SEMICON CO., LTD.	
1, Hyangjeong-Dong, Hungduk-Gu, Cheongju	
Choongcheonghuk-Do, Korea	
its successors and assigns (hereinafter designated "ASSIGNEE") the entire r invention entitled	right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the
SEMICONDUCTOR WAFER AND FABRICATION METHOD (OF A SEMICONDUCTOR CHIP
(a) for which an application for United States Letters Patent was filed on	, and identified by United States Serial No; or
(b) for which an application for United States Letters Patent was executed	August 29 and September 10, 1998
may be granted therefor and any and all extensions, divisions, reissues, substi	ssioner of Patents and Trademarks to issue any and all United States Letters Patent which itutes, renewals, continuations, or continuations-in-part thereof, and the right to all benefits erty to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal application shall hereafter act on behalf of said ASSIGNEE;
divisional, reissued or extended Letters Patent of the United States, upon rec- further remuneration, in and to any improvements, and applications for pate	and to render all necessary assistance in making application for and obtaining original, quest of the said ASSIGNEE, its successors, assigns and legal representatives, and without ent based thereon, growing out of or related to the said invention; and to execute any papers deemed essential to ASSIGNEE's full protection and title in and to the invention hereby
SIGNED on the dates indicated aside our signatures: INVENTORS	DATE SIGNED
1) Jacubonkin Name: Jae Woon KIM	Aug. 29. 1888
2) Jonghoon, Park Name: Jong Hoon PARK	Sep. 10. 1998
3)Name:	
4) Name:	
5)Name:	

PATENT REEL: 9471 FRAME: 0638

Name: